![Infineon logo]

Rev. 2.1

BSO 612 CV G

SIPMOS$^\circledR$ Small-Signal-Transistor

Features

- Dual N- and P -Channel
- Enhancement mode
- Avalanche rated
- Pb-free lead plating;RoHS compliant

Product Summary

		N	P	
Drain source voltage	V_{DS}	60	-60	V
Drain-Source on-state resistance	$R_{DS(on)}$	0.12	0.3	Ω
Continuous drain current	I_D	3	-2	A

Top View   SIS00059

VPS05121
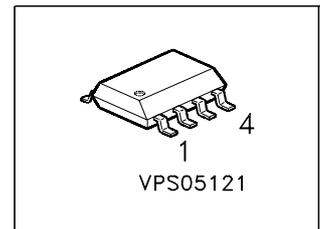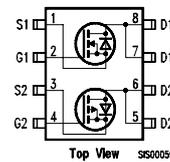
Type	Package	Marking
BSO 612 CV	PG-DSO-8	612CV

Maximum Ratings, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Value		Unit
		N	P	
Continuous drain current	I_D			A
T_A = 25 °C		3	-2	
T_A = 70 °C		2.4	-1.6	
Pulsed drain current	$I_{D\,puls}$	12	-8	
T_A = 25 °C				
Avalanche energy, single pulse	E_{AS}			mJ
I_D = 3 A, V_{DD} = 25 V, R_{GS} = 25 Ω		47	-	
I_D = -2 A, V_{DD} = -25 V, R_{GS} = 25 Ω		-	70	
Avalanche energy, periodic limited by T_{jmax}	E_{AR}	0.2	0.2	
Reverse diode dv/dt, T_{jmax} = 150 °C	dv/dt			kV/µs
I_S = 3 A, V_{DS} = 48 V, di/dt = 200 A/µs		6	-	
I_S = -2 A, V_{DS} = -48 V, di/dt = -200 A/µs		-	6	
Gate source voltage	V_{GS}	±20	±20	V
Power dissipation	P_{tot}	2	2	W
T_A = 25 °C				
Operating and storage temperature	T_j , T_{stg}	-55...+150		°C
IEC climatic category; DIN IEC 68-1		55/150/56		

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Termal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Thermal resistance, junction - soldering point N	R_{thJS}	-	-	40	K/W
(Pin 4) P		-	-	40	
SMD version, device on PCB:	R_{thJA}				
@ min. footprint; t ≤ 10 sec. N		-	-	110	
@ 6 cm[2] cooling area [1]; t ≤ 10 sec. N		-	-	62.5	
@ min. footprint; t ≤ 10 sec. P		-	-	70	
@ 6 cm[2] cooling area [1]; t ≤ 10 sec. P		-	-	62.5	
Static Characteristics, at T_j = 25 °C, unless otherwise specified					
Drain- source breakdown voltage	$V_{(BR)DSS}$				V
V_{GS} = 0 V, I_D = 250 µA N		60	-	-	
V_{GS} = 0 V, I_D = -250 µA P		-60	-	-	
Gate threshold voltage, V_{GS} = V_{DS}	$V_{GS(th)}$				
I_D = 20 µA N		2.1	3	4	
I_D = -450 µA P		-2.1	-3	-4	
Zero gate voltage drain current	I_{DSS}				µA
V_{DS} = 60 V, V_{GS} = 0 V, T_j = 25 °C N		-	0.1	1	
V_{DS} = 60 V, V_{GS} = 0 V, T_j = 125 °C N		-	10	100	
V_{DS} = -60 V, V_{GS} = 0 V, T_j = 25 °C P		-	-0.1	-1	
V_{DS} = -60 V, V_{GS} = 0 V, T_j = 125 °C P		-	-10	-100	
Gate-source leakage current	I_{GSS}				nA
V_{GS} = 20 V, V_{DS} = 0 V N		-	10	100	
V_{GS} = -20 V, V_{DS} = 0 V P		-	-10	-100	
Drain-source on-state resistance	$R_{DS(on)}$				Ω
V_{GS} = 10 V, I_D = 3 A N		-	0.09	0.12	
V_{GS} = -10 V , I_D = -2 A P		-	0.22	0.3	

[1]Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm [2] (one layer, 70 µm thick) copper area for drain connection. PCB is vertical without blown air.

BSO 612 CV G

Electrical Characteristics , at T_j = 25 °C, unless otherwise specified

Parameter		Symbol	Values			Unit
			min.	typ.	max.	
Characteristics						
Transconductance		g_{fs}				S
$V_{DS}{\geq}2*I_D*R_{DS(on)max}$, I_D = 3 A	N		2	4	-	
$VV_{DS}{\geq}2*I_D*R_{DS(on)max}$, I_D = -2 A	P		1.2	2.4	-	
Input capacitance		C_{iss}				pF
V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	N		-	275	340	
V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz	P		-	320	400	
Output capacitance		C_{oss}				
V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	N		-	90	115	
V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz	P		-	105	130	
Reverse transfer capacitance		C_{rss}				
V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	N		-	50	65	
V_{GS} = 0 V, V_{DS} = -25 V, f = 1 MHz	P		-	40	50	
Turn-on delay time		$t_{d(on)}$				ns
V_{DD} = 30 V, V_{GS} = 10 V, I_D = 3 A , R_G = 33 Ω	N		-	12	18	
V_{DD} = -30 V, V_{GS} = -10 V, I_D = -2 A , R_G = 27 Ω	P		-	15	23	
Rise time		t_r				
V_{DD} = 30 V, V_{GS} = 10 V, I_D = 3 A, R_G = 33 Ω	N		-	35	55	
V_{DD} = -30 V, V_{GS} = -10 V, I_D = -2 A, R_G = 27 Ω	P		-	60	90	
Turn-off delay time		$t_{d(off)}$				
V_{DD} = 30 V, V_{GS} = 10 V, I_D = 3 A , R_G = 33 Ω	N		-	25	40	
V_{DD} = -30 V, V_{GS} = -10 V, I_D = -2 A , R_G = 27 Ω	P		-	145	220	
Fall time		t_f				
V_{DD} = 30 V, V_{GS} = 10 V, I_D = 3 A , R_G = 33 Ω	N		-	30	45	
V_{DD} = -30 V, V_{GS} = -10 V, I_D = -2 A , R_G = 27 Ω	P		-	95	140	

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Electrical Characteristics, at T_j = 25 °C, unless otherwise specified

Parameter		Symbol	Values			Unit
			min.	typ.	max.	
Characteristics						
Gate to source charge		Q_{gs}				nC
V_{DD} = 48 V, I_D = 3 A	N		-	1	1.5	
V_{DD} = -48 V, I_D = -2 A	P		-	2	3	
Gate to drain charge		Q_{gd}				
V_{DD} = 48 V, I_D = 3 A	N		-	5.5	8.3	
V_{DD} = -48 V, I_D = -2 A	P		-	4.5	6.8	
Gate charge total		Q_g				
V_{DD} = 48 V, I_D = 3 A, V_{GS} = 0 to 10V	N		-	10.3	15.5	
V_{DD} = -48 V, I_D = -2 A, V_{GS} = 0 to -10V	P		-	10.5	16	
Gate plateau voltage		$V_{(plateau)}$				V
V_{DD} = 48 V, I_D = 3 A	N		-	5	-	
V_{DD} = -48 V, I_D = -2 A	P		-	-4	-	
Reverse Diode						
Inverse diode continuous forward current	N	I_S	-	-	3	A
T_A = 25 °C	P		-	-	-2	
Inverse diode direct current,pulsed	N	I_{SM}	-	-	12	
T_A = 25 °C	P		-	-	-8	
Inverse diode forward voltage		V_{SD}				V
V_{GS} = 0 V, I_F = I_S	N		-	0.9	1.2	
V_{GS} = 0 V, I_F = I_S	P		-	-0.9	-1.2	
Reverse recovery time		t_{rr}				ns
V_R = 30 V, $I_F=I_S$, di_F/dt = 100 A/µs	N		-	55	85	
V_R = -30 V, $I_F=I_S$, di_F/dt = -100 A/µs	P		-	55	85	
Reverse recovery charge		Q_{rr}				nC
V_R = 30 V, $I_F=I_S$, di_F/dt = 100 A/µs	N		-	90	135	
V_R = -30 V, $I_F=I_S$, di_F/dt = -100 A/µs	P		-	65	100	

Power Dissipation (N-Ch.)

$P_{tot} = f(T_A)$

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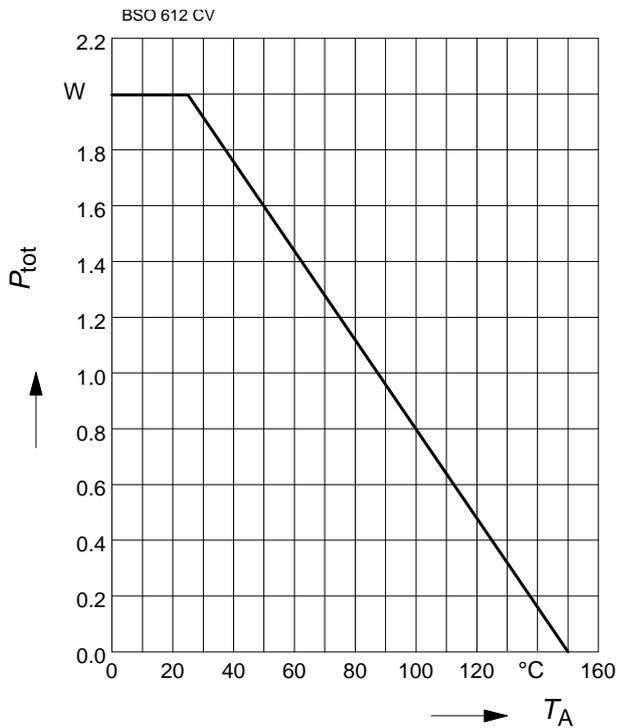
Power Dissipation (P-Ch.)

$P_{tot} = f(T_A)$

BSO 612 CV
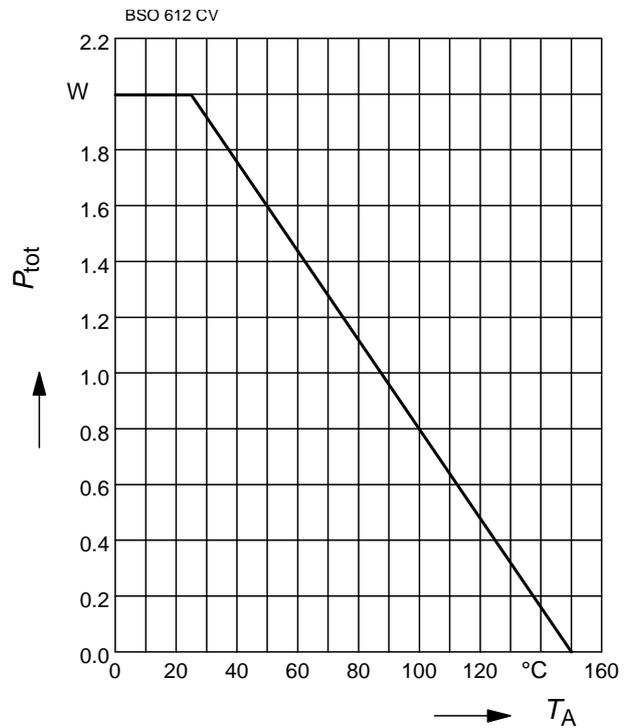
Drain current (N-Ch.)

$I_D = f(T_A)$

parameter: $V_{GS} \geq 10$ V

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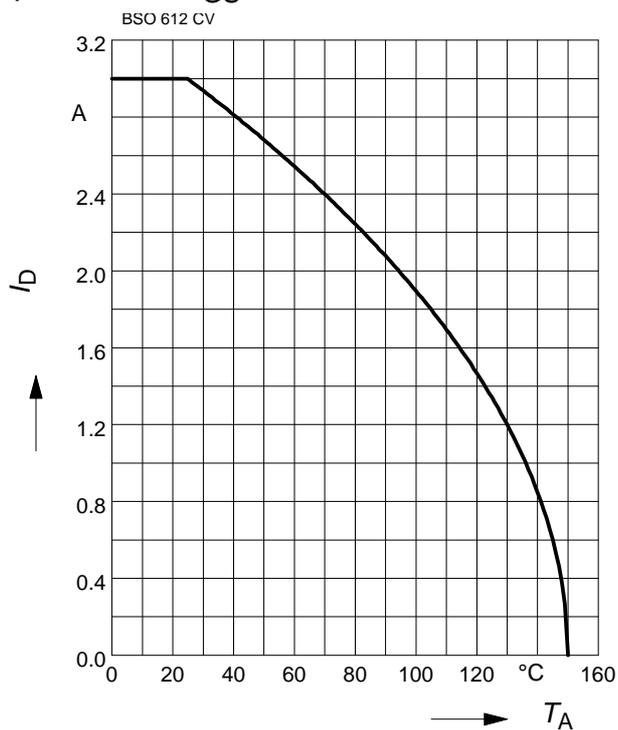
Drain current (P-Ch.)

$I_D = f(T_A)$

parameter: $V_{GS} \geq -10$ V
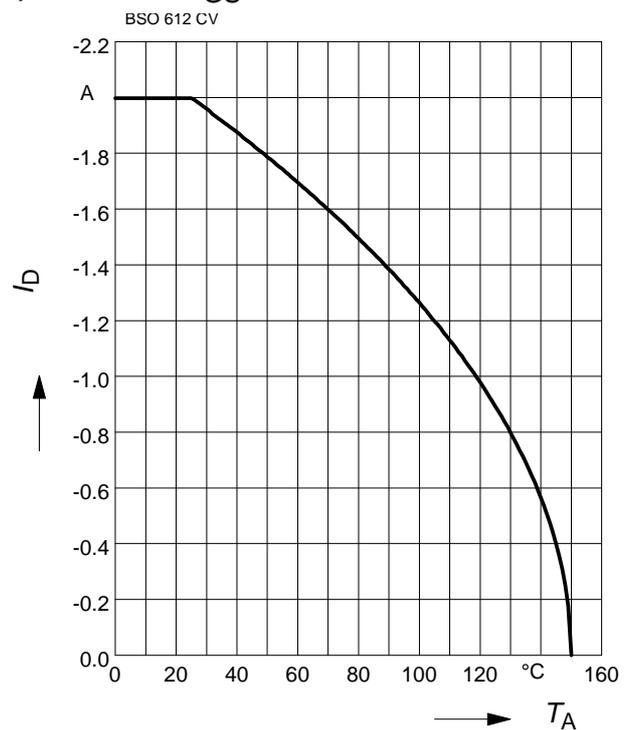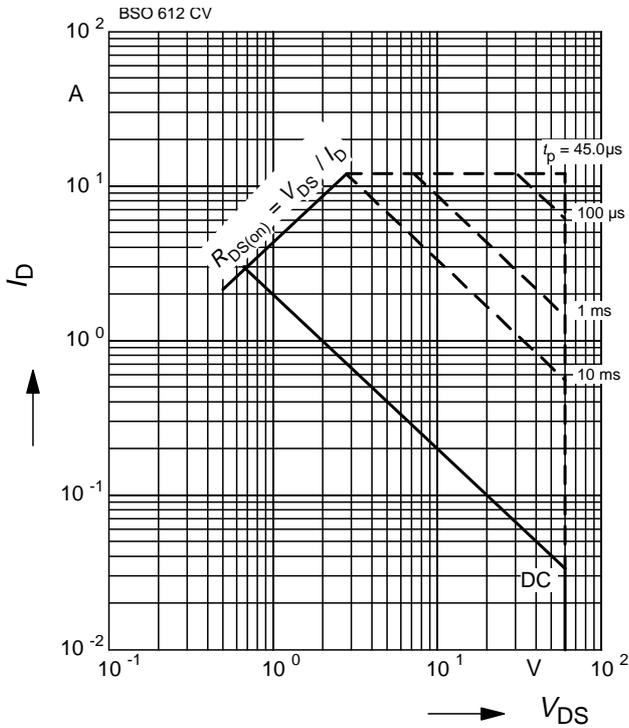
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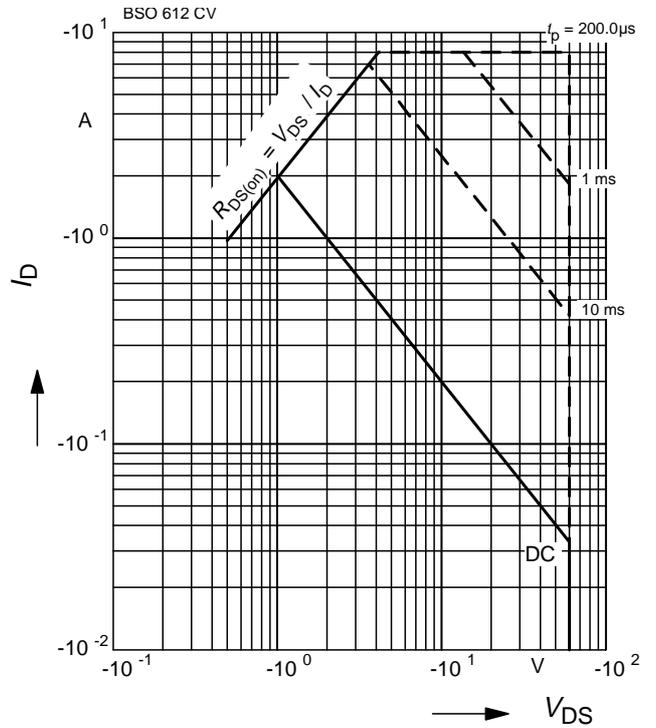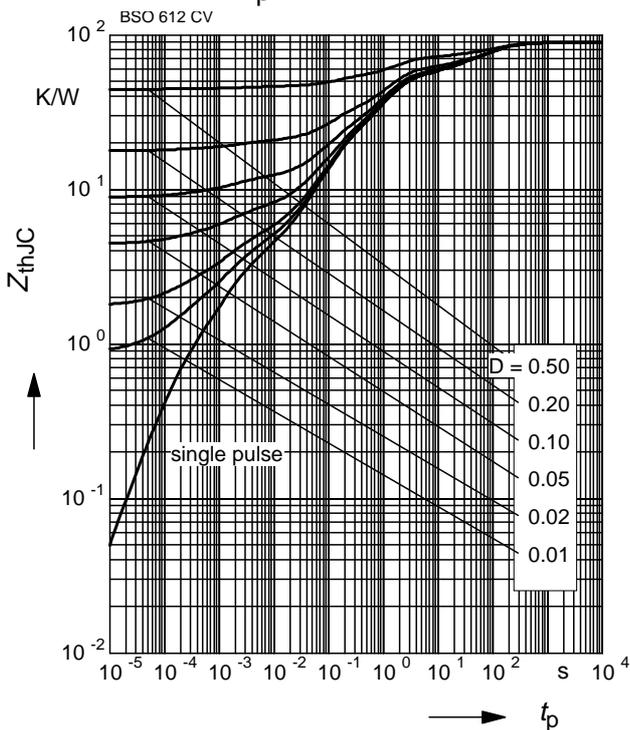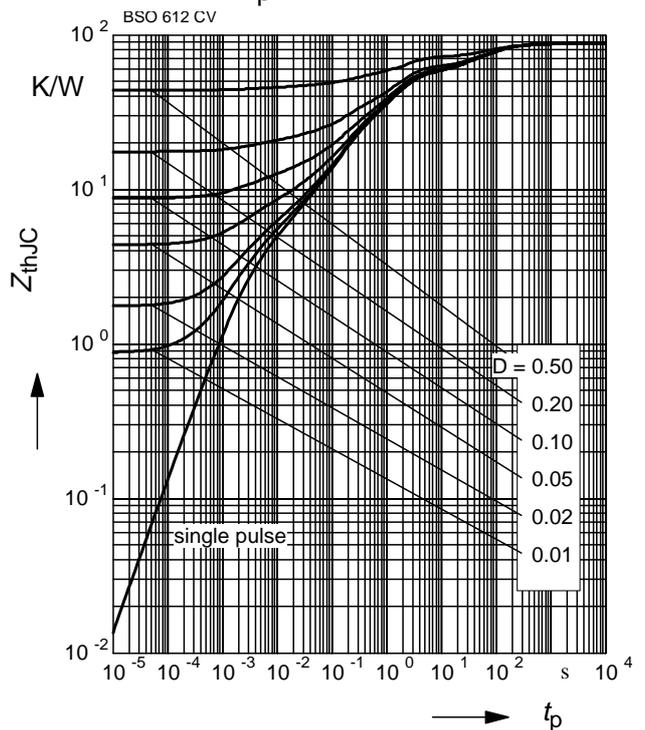
Typ. output characteristics (N-Ch.)

$I_D = f(V_{DS})$

parameter: $t_p = 80$ μs

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	V_{GS} [V]
a	4.0
b	4.2
c	4.5
d	4.7
e	5.0
f	5.2
g	5.5
h	5.7
i	6.0
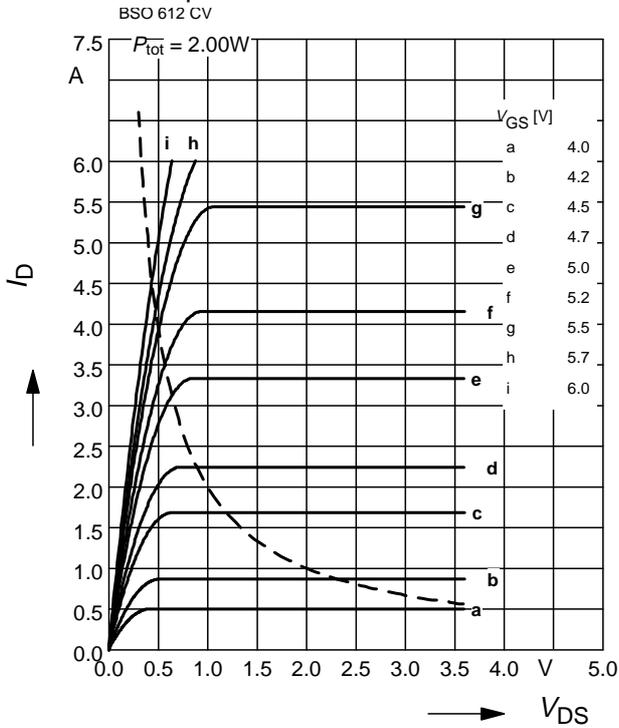
Typ. output characteristics (P-Ch.)

$I_D = f(V_{DS})$

parameter: $t_p = 80$ μs

BSO 612 CV

	V_{GS} [V]
a	-4.0
b	-4.2
c	-4.5
d	-4.7
e	-5.0
f	-6.0
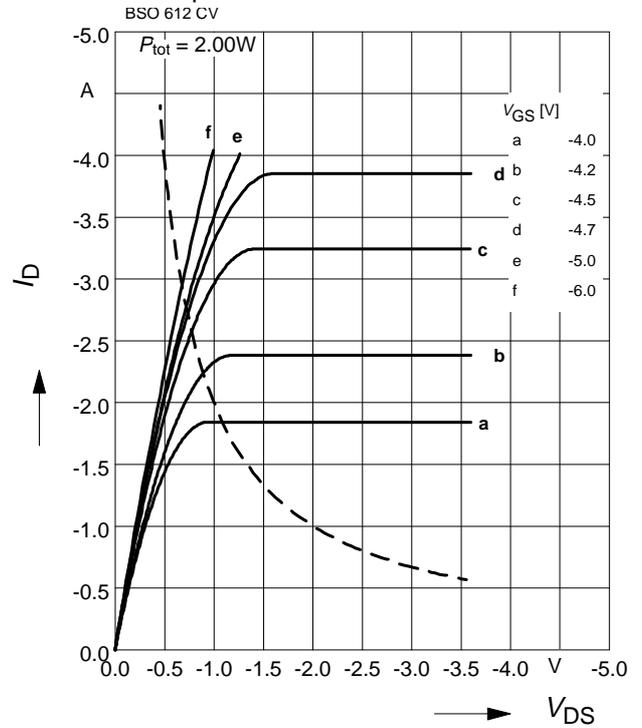
Typ. drain-source-on-resistance (N-Ch.)

$R_{DS(on)} = f(I_D)$

parameter: V_{GS}

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V_{GS} [V] =							
b	c	d	e	f	g	h	i
4.2	4.5	4.7	5.0	5.2	5.5	5.7	6.0
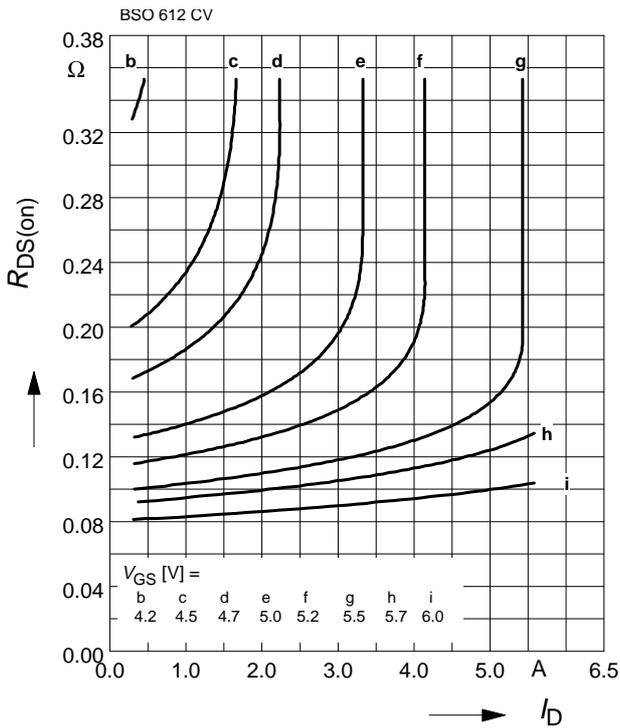
Typ. drain-source-on-resistance (P-Ch.)

$R_{DS(on)} = f(I_D)$

parameter: V_{GS}

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V_{GS} [V] =					
a	b	c	d	e	f
-4.0	-4.2	-4.5	-4.7	-5.0	-6.0

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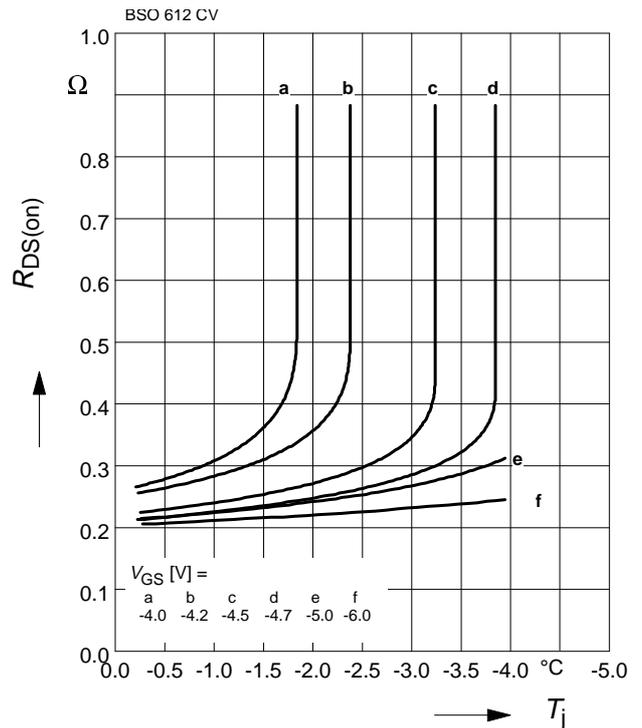
Typ. transfer characteristics (N-Ch.)

parameter: t_p = 80 µs

$I_D = f(V_{GS})$, $V_{DS} \geq 2$ x I_D x $R_{DS(on)max}$
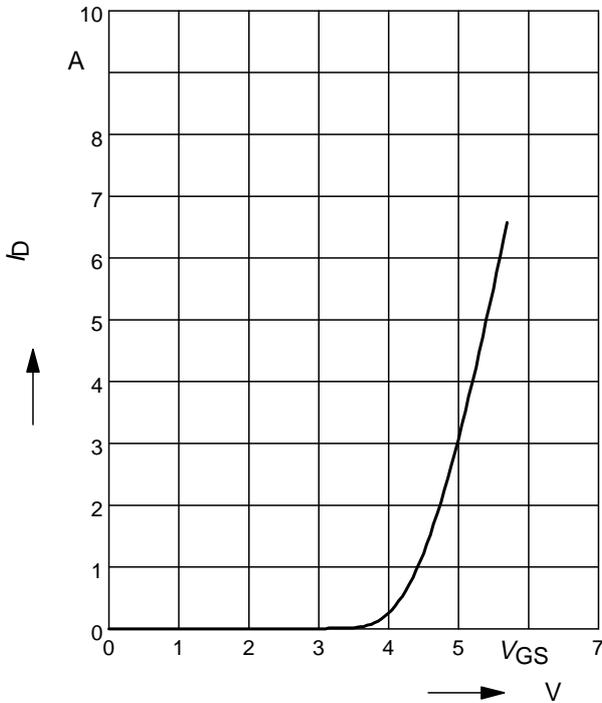
Typ. transfer characteristics (P-Ch.)

parameter: t_p = 80 µs

$I_D = f(V_{GS})$, $V_{DS} \geq 2$ x I_D x $R_{DS(on)max}$
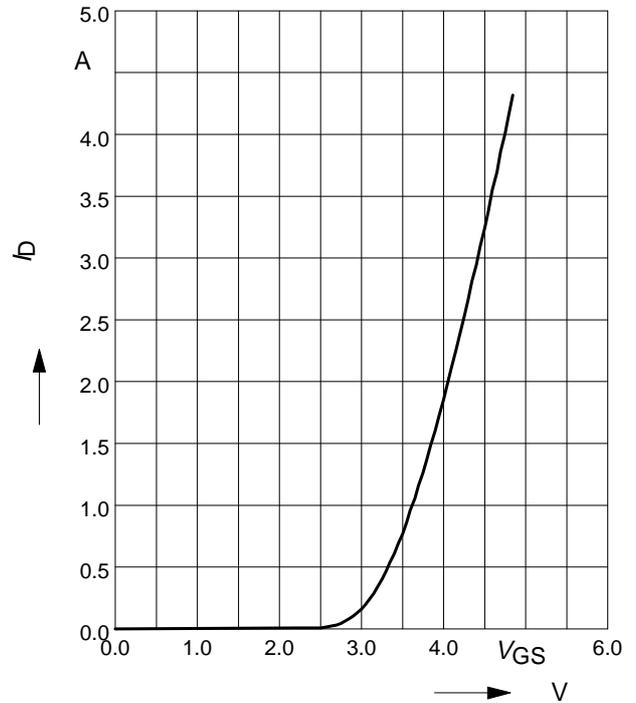
Typ. forward transconductance (N-Ch.)

g_{fs} = f(I_D); T_j = 25 °C

parameter: g_{fs}
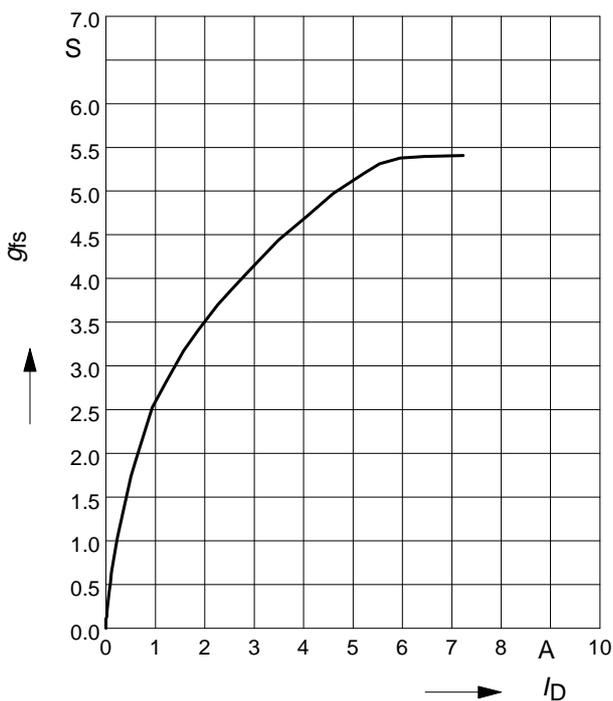
Typ. forward transconductance (P-Ch.)

g_{fs} = f(I_D); T_j = 25 °C

parameter: g_{fs}
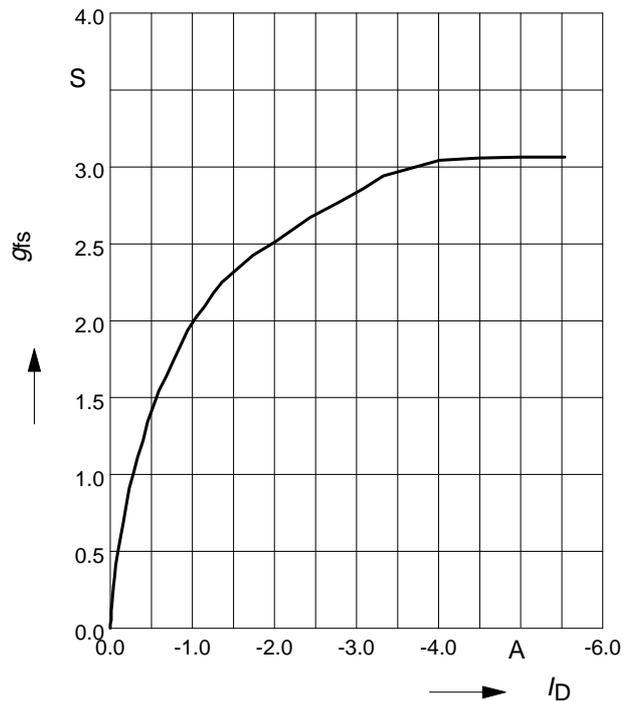
Drain-source on-resistance (N-Ch.)

$R_{DS(on)} = f(T_j)$

parameter : $I_D = 3\,A$, $V_{GS} = 10\,V$
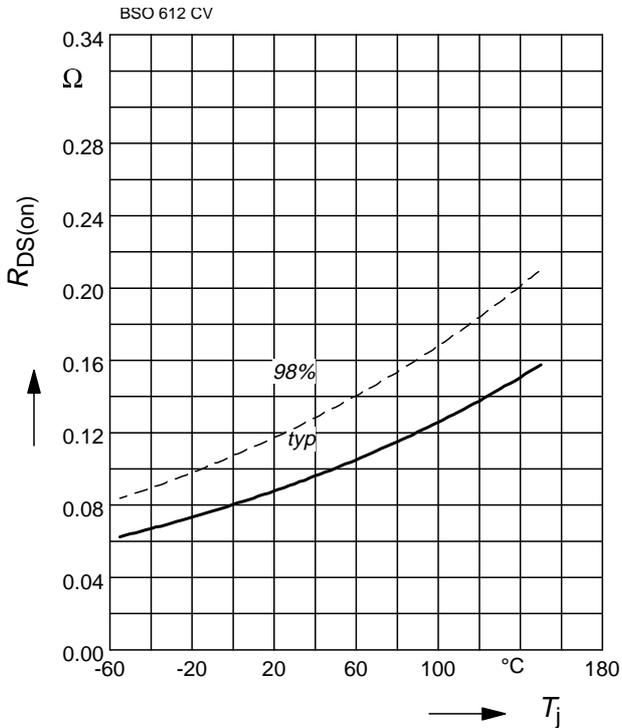
Drain-source on-resistance (P-Ch.)

$R_{DS(on)} = f(T_j)$

parameter : $I_D = -2\,A$, $V_{GS} = -10\,V$
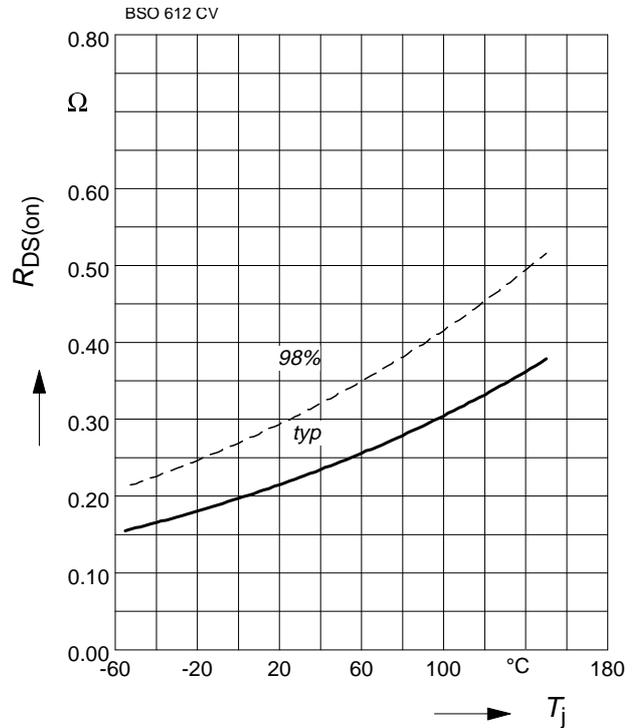
**Gate threshold voltage** (N-Ch.)

$V_{GS(th)} = f(T_j)$

parameter: $V_{GS} = V_{DS}$, $I_D = 20\,\mu A$
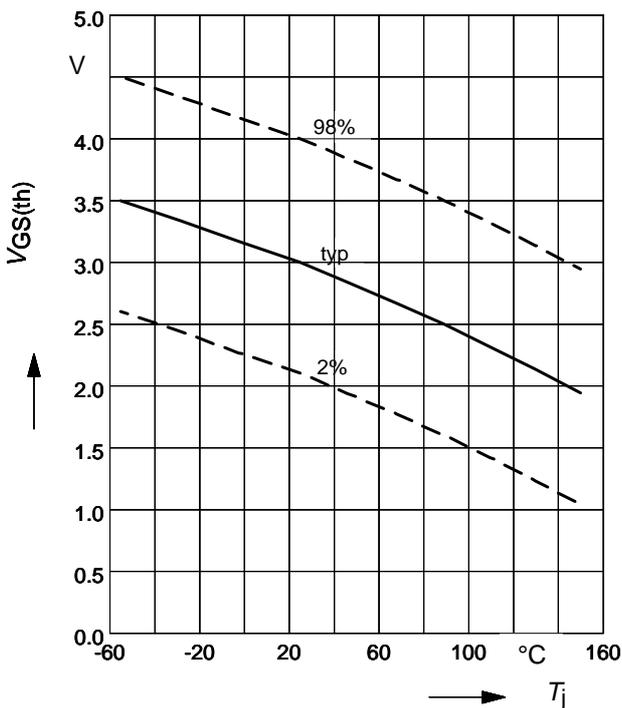


Gate threshold voltage (P-Ch.)

$V_{GS(th)} = f(T_j)$

parameter: $V_{GS} = V_{DS}$, $I_D = -450\,\mu A$


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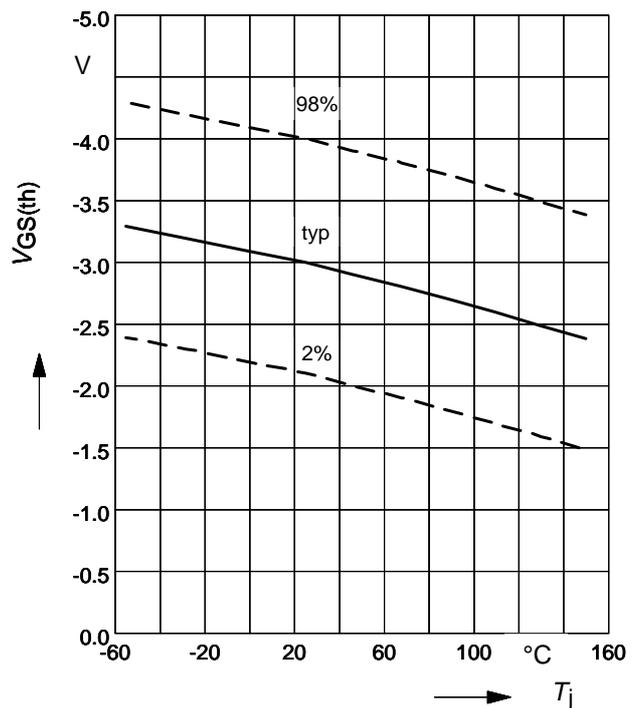
Typ. capacitances (N-Ch.)

$C = f(V_{DS})$

parameter: $V_{GS}=0$ V, $f=1$ MHz
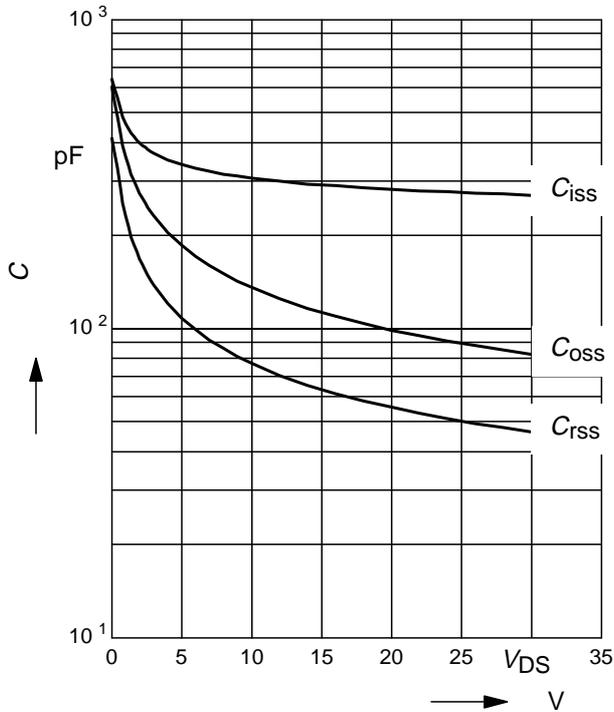
Typ. capacitances (P-Ch.)

$C = f(V_{DS})$

parameter: $V_{GS}=0$ V, $f=1$ MHz
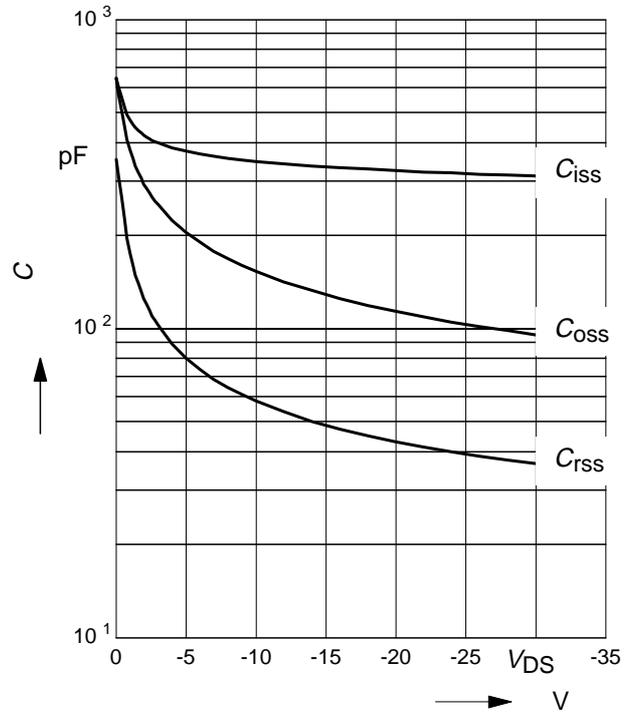
**Forward characteristics of reverse diode**

$I_F = f(V_{SD})$, (N-Ch.)

parameter: T_j , $t_P = 80$ μs
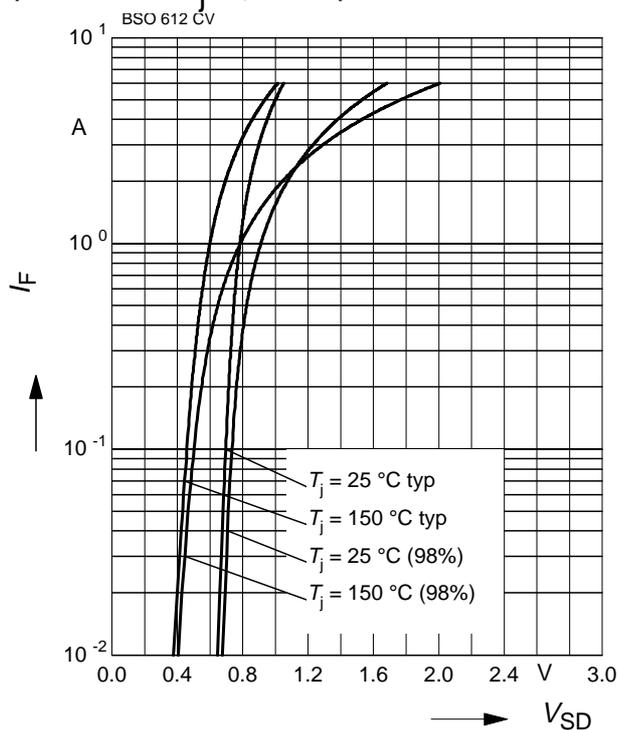
Forward characteristics of reverse diode

$I_F = f(V_{SD})$, (P-Ch.)

parameter: T_j , $t_p = 80$ μs

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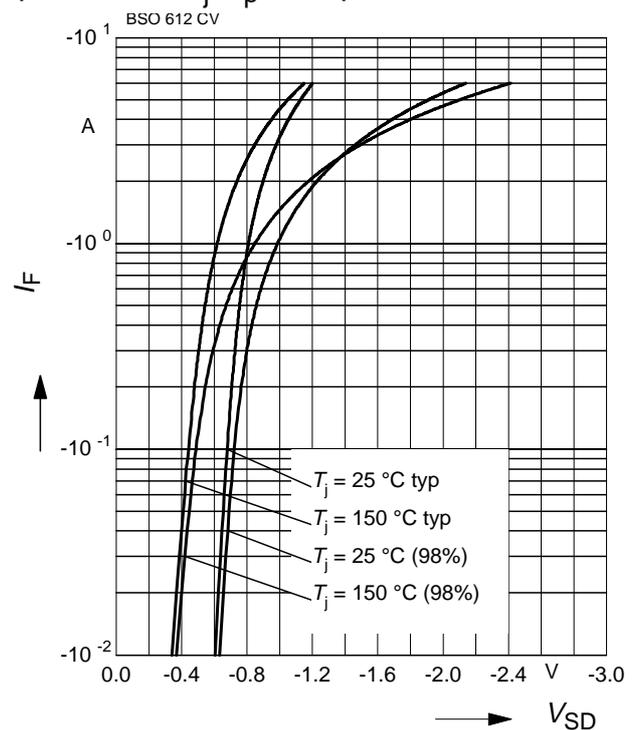
Avalanche Energy $E_{AS} = f(T_j)$ (N-Ch.)

parameter: $I_D = 3$ A, $V_{DD} = 25$ V

$R_{GS} = 25\ \Omega$
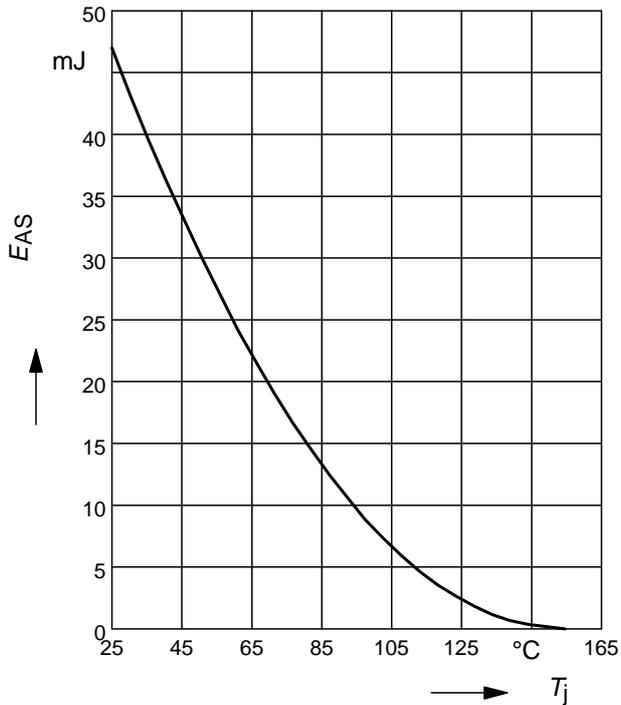
Avalanche Energy $E_{AS} = f(T_j)$

parameter: $I_D = -2$ A, $V_{DD} = -25$ V

$R_{GS} = 25\ \Omega$
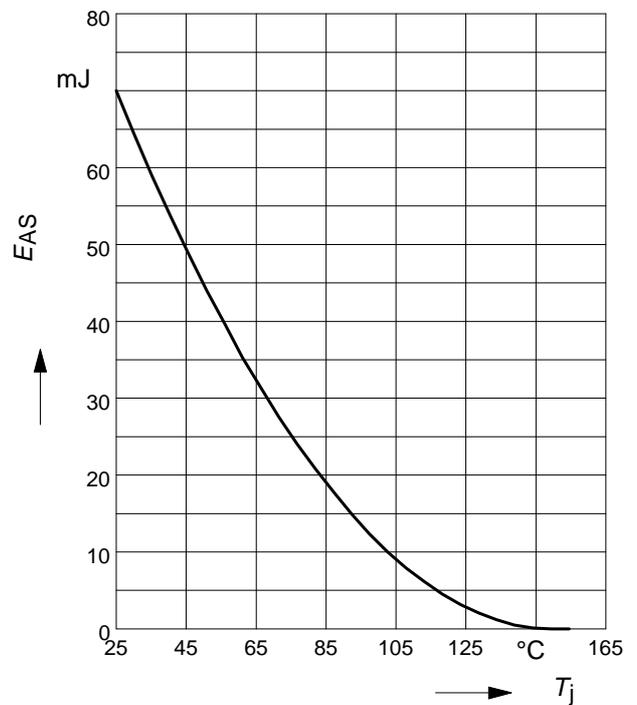
Typ. gate charge (N-Ch.)

$V_{GS} = f(Q_{Gate})$

parameter: $I_D = 3$ A
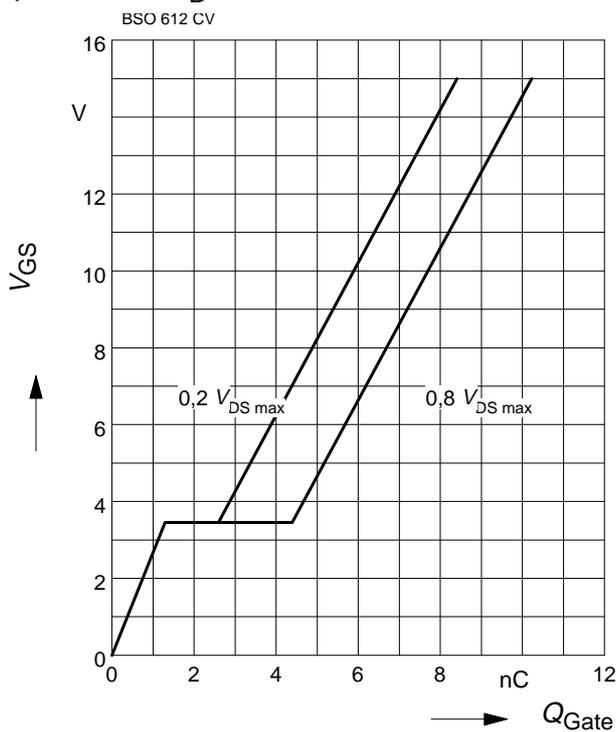
Typ. gate charge (P-Ch.)

$V_{GS} = f(Q_{Gate})$

parameter: $I_D = -2$ A

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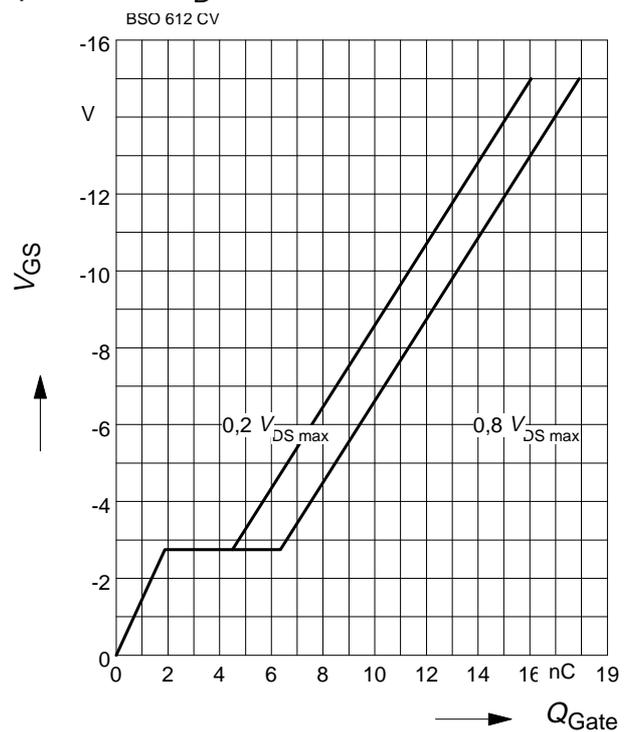
Drain-source breakdown voltage

$V_{(BR)DSS} = f(T_j)$, (N-Ch.)
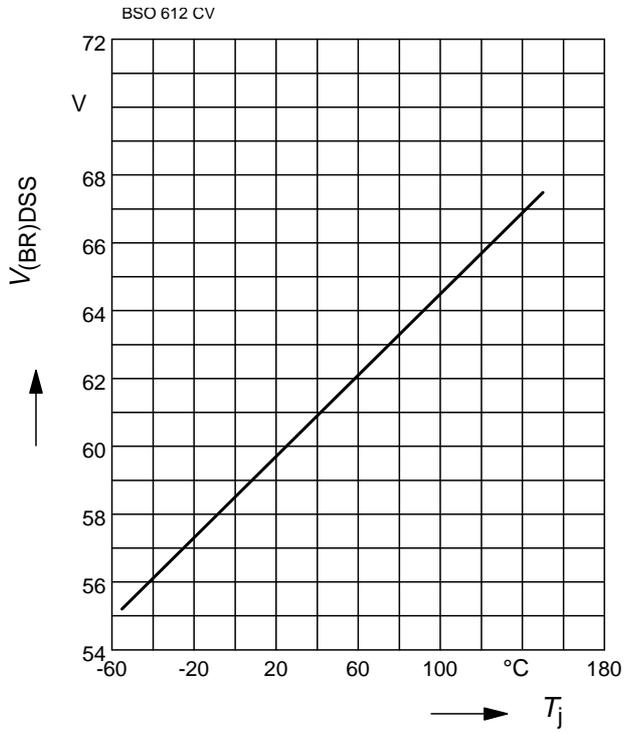
Drain-source breakdown voltage

$V_{(BR)DSS} = f(T_j)$, (P-Ch.)
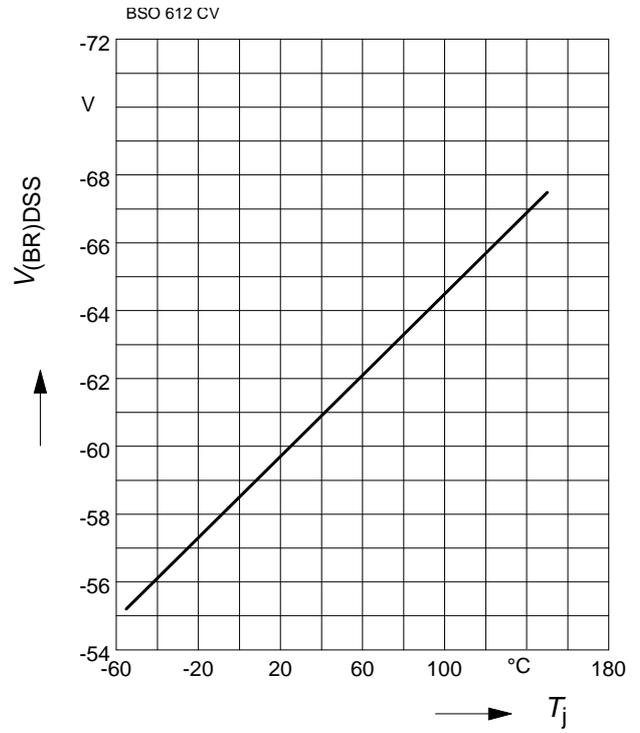
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